



# STS12NF30L

N-channel 30V - 0.008Ω - 12A SO-8  
STripFET™ II Power MOSFET

## General features

Type	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STS12NF30L	30V	<0.009Ω	12A

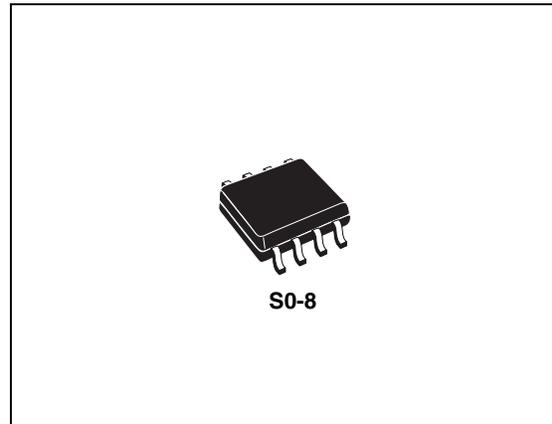
- Standard outline for easy automated surface mount assembly
- Low threshold drive

## Description

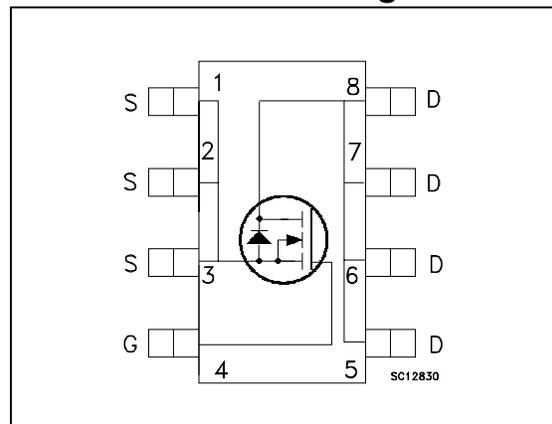
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

## Applications

- Switching application



## Internal schematic diagram



## Order codes

Part number	Marking	Package	Packaging
STS12NF30L	S12NF30L	SO-8	Tape & reel

## Contents

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# 1 Electrical ratings

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage ( $v_{GS} = 0$ )	30	V
$V_{GS}$	Gate- source voltage	$\pm 16$	V
$I_D$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	12	A
$I_D$	Drain current (continuous) at $T_C = 100^\circ\text{C}$	7.5	A
$I_{DM}^{(1)}$	Drain current (pulsed)	48	A
$P_{TOT}$	Total dissipation at $T_C = 25^\circ\text{C}$	2.5	W

1. Pulse width limited by safe operating area

**Table 2. Thermal data**

$R_{thj-a}$	Thermal resistance junction-ambient Max	50	$^\circ\text{C}/\text{W}$
$T_J$	Maximum operating junction temperature	150	$^\circ\text{C}$
$T_{stg}$	Storage temperature	-55 to 150	$^\circ\text{C}$

## 2 Electrical characteristics

( $T_{CASE}=25^{\circ}C$  unless otherwise specified)

**Table 3. On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source Breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	30			V
$I_{DSS}$	Zero gate voltage Drain current ( $V_{GS} = 0$ )	$V_{DS} = \text{Max rating}$ $V_{DS} = \text{Max rating}, T_C = 125^{\circ}C$			1 10	$\mu A$ $\mu A$
$I_{GSS}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 16V$			$\pm 100$	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1			V
$R_{DS(on)}$	Static drain-source on resistance	$V_{GS} = 10V, I_D = 6A$ $V_{GS} = 4.5V, I_D = 6A$		0.008 0.01	0.009 0.011	$\Omega$ $\Omega$

**Table 4. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$g_{fs}^{(1)}$	Forward transconductance	$V_{DS} = 15V, I_D = 6A$		15		S
$C_{iss}$	Input capacitance	$V_{DS} = 25V, f = 1 \text{ MHz}, V_{GS} = 0$		2400		pF
$C_{oss}$	Output capacitance			590		pF
$C_{rss}$	Reverse transfer capacitance			200		pF
$Q_g$	Total gate charge	$V_{DD} = 24V, I_D = 12A,$ $V_{GS} = 4.5V$ (see Figure 13)		35	50	nC
$Q_{gs}$	Gate-source charge			9		nC
$Q_{gd}$	Gate-drain charge			18		nC

1. Pulsed: Pulse duration = 300  $\mu s$ , duty cycle 1.5.

**Table 5. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 15V, I_D = 6A,$ $R_G = 4.7\Omega, V_{GS} = 4.5V$ (see Figure 12)		35		ns
$t_r$	Rise time			90		ns
$t_{d(off)}$	Turn-off-delay time	$V_{DD} = 15V, I_D = 6A,$ $R_G = 4.7\Omega, V_{GS} = 4.5V$ (see Figure 12)		80		ns
$t_f$	Fall time			35		ns
$t_{r(Voff)}$	Off-voltage rise time	$V_{DD} = 24V, I_D = 12A,$ $R_G = 4.7\Omega, V_{GS} = 4.5V$ (see Figure 14)		35		ns
$t_f$	fall time			35		ns
$t_c$	cross-over time			80		ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max	Unit
$I_{SD}$	Source-drain current				40	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)				160	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 12A, V_{GS} = 0$			1.3	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 12A, V_{DD} = 15V$ $di/dt = 100A/\mu s,$ $T_j = 150^\circ C$ (see Figure 14)		114		ns
$Q_{rr}$	Reverse recovery charge			456		nC
$I_{RRM}$	Reverse recovery current			8		A

1. Pulse width limited by safe operating area.
2. Pulsed: Pulse duration = 300  $\mu s$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

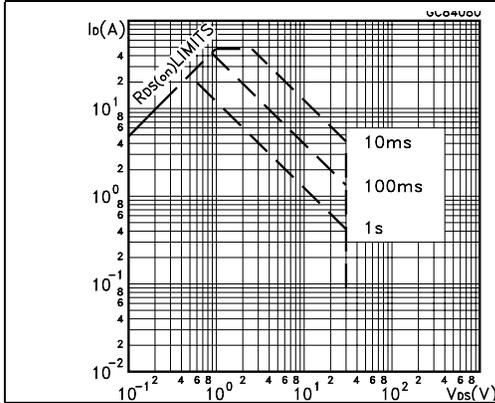


Figure 2. Thermal impedance

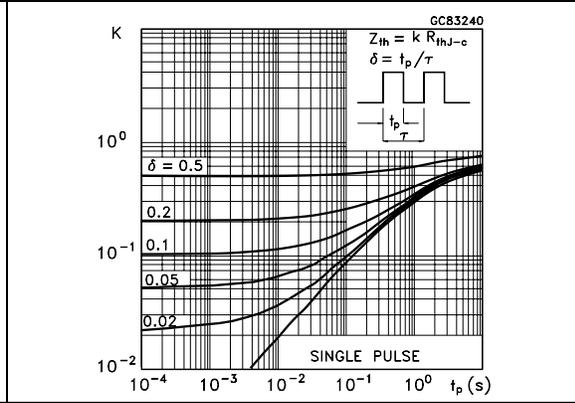


Figure 3. Output characteristics

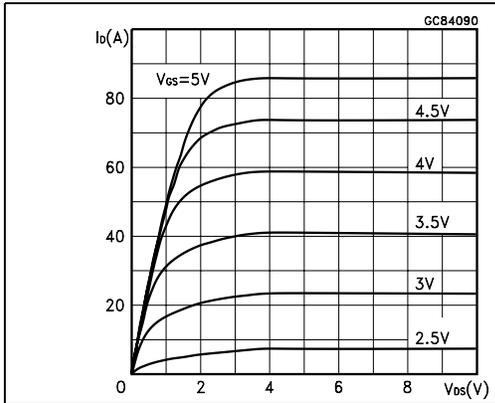


Figure 4. Transfer characteristics

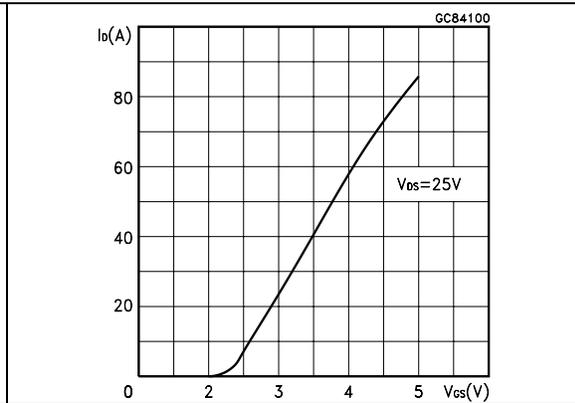


Figure 5. Transconductance

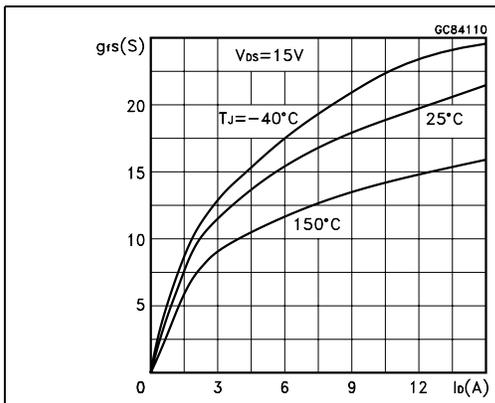


Figure 6. Static drain-source on resistance

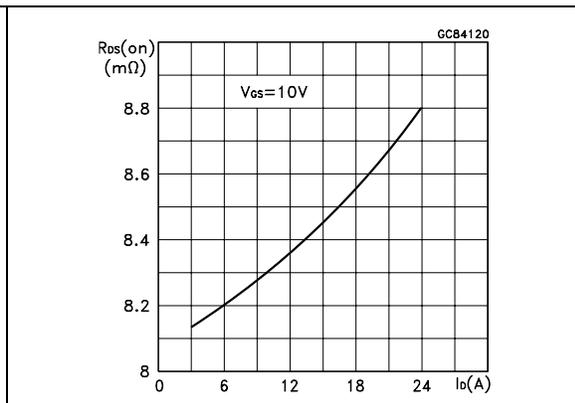


Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

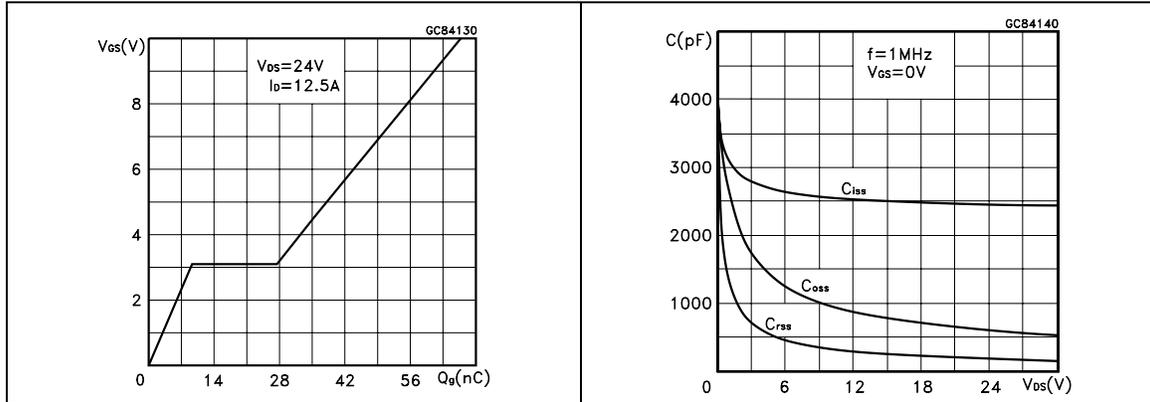


Figure 9. Normalized gate threshold voltage vs. temperature Figure 10. Normalized on resistance vs. temperature

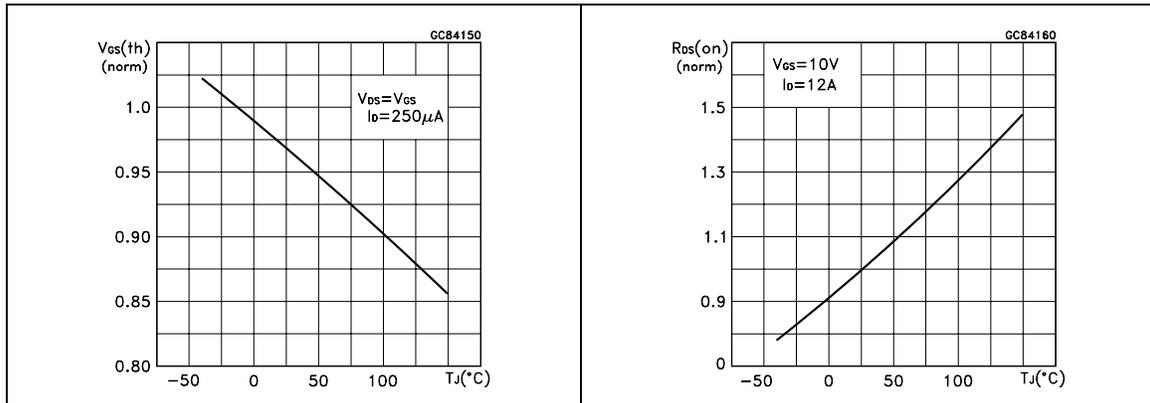
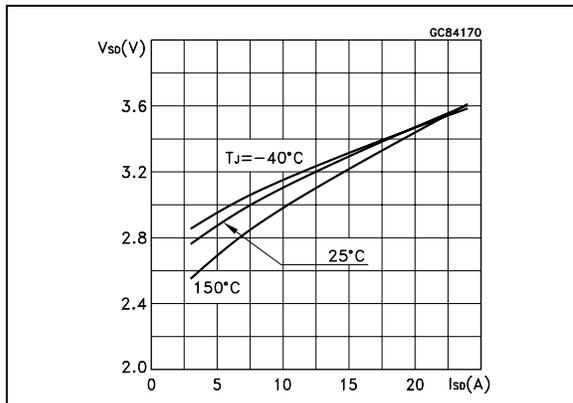


Figure 11. Source-drain diode forward characteristics



### 3 Test circuit

Figure 12. Switching times test circuit for resistive load

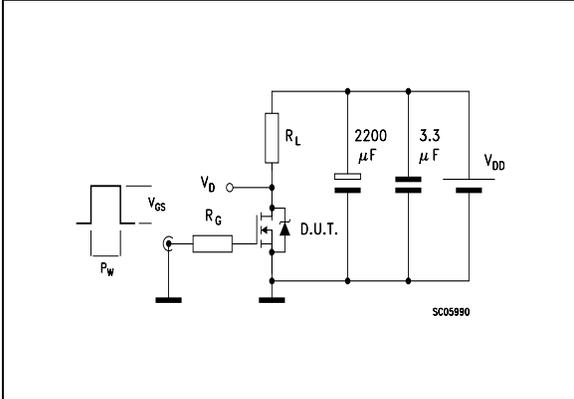


Figure 13. Gate charge test circuit

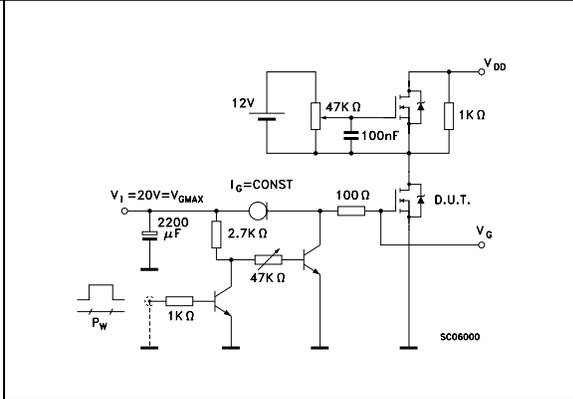


Figure 14. Test circuit for inductive load switching and diode recovery times

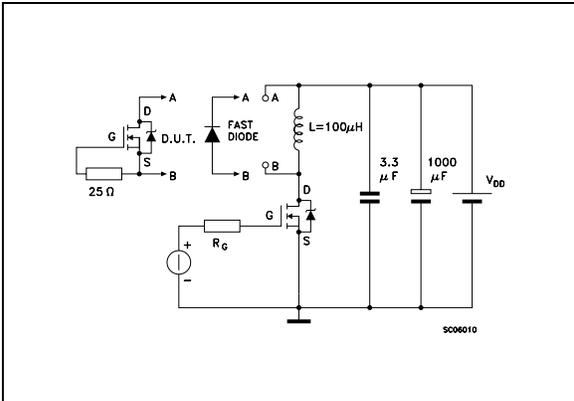


Figure 15. Unclamped Inductive load test circuit

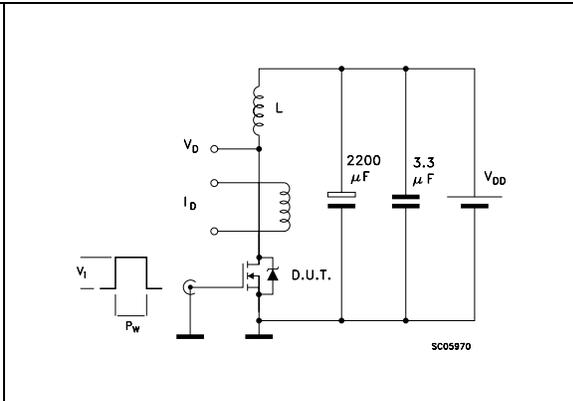


Figure 16. Unclamped inductive waveform

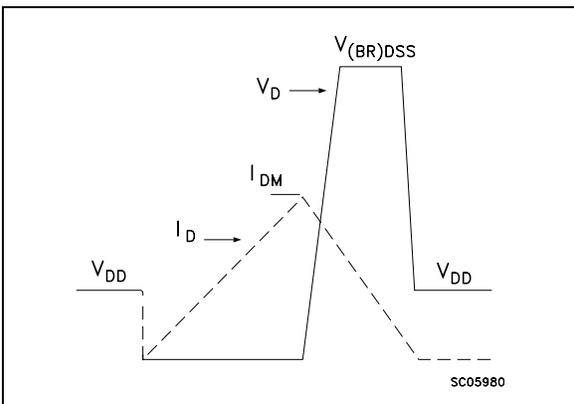
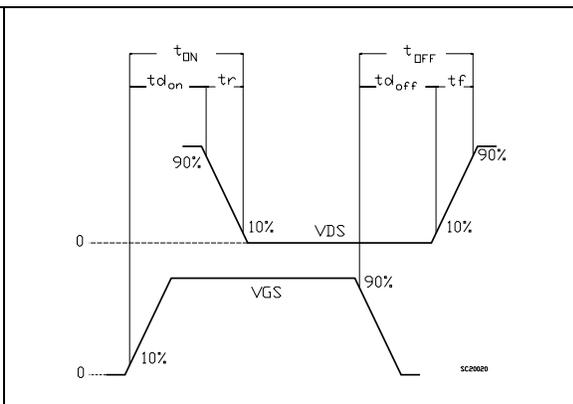


Figure 17. Switching time waveform

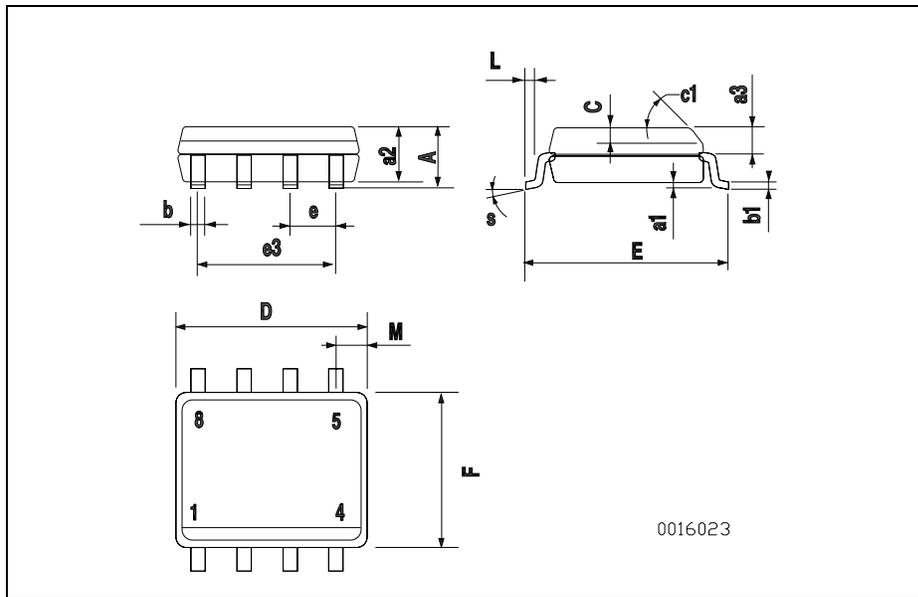


## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at : [www.st.com](http://www.st.com)

**SO-8 MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.019
c1	45 (typ.)					
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
M			0.6			0.023
S	8 (max.)					



## 5 Revision history

Table 7. Revision history

Date	Revision	Changes
09-Sep-2004	6	Complete version
17-Aug-2006	7	New template, no content change
31-Jan-2007	8	Typo mistake on <a href="#">Table 1</a> .

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